

# Product Change Notification 113269 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# **Product Change Notification**

Change Notification #: 113269-01

Change Title: Intel® Compute Module HNS2600JFQ and

HNS2600JFF

PCN113269-01, Product Material

Change the material of tray latch cap from

rubber to polycarbonate

**Reason for Revision:** 

**Add Additional Product SKU** 

Date of Publication: October 23, 2014

#### **Key Characteristics of the Change:**

Product Material

#### **Forecasted Key Milestones:**

Date Customer Must be Ready to Receive Post-Conversion Material \*:

October 23, 2014

#### **Description of Change to the Customer:**

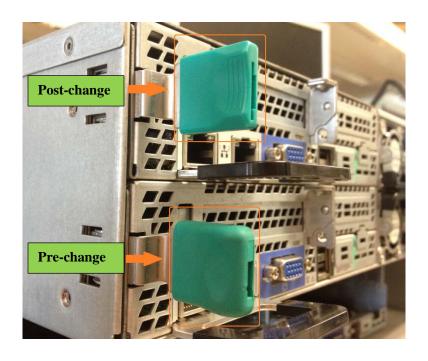
#### Reason for Revision: Add Additional Product SKU

Intel is implementing the following change on the Intel<sup>®</sup> Compute Module HNS2600JFQ and HNS2600JFF:

Change the material of tray latch cap from rubber to polycarbonate to avoid pulling the cap out from the tray latch.

See below picture: the lower one is pre-change cap and the upper one is post-change cap.

<sup>\*</sup> Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.



### **Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customers. Customers may need to validate the function and feature changes after receiving the system.

# **Products Affected / Intel Ordering Codes:**

ASMO SKU			
<b>Product Code</b>	MM#	Pre Change TA	Post Change TA
HNS2600JFQ	918335	G51249-002	G51249-003
HNS2600JFF	921301	G58694-001	G58694-002

## **PCN Revision History:**

Date of Revision:Revision Number:Reason:October 8, 201400Originally Published PCNOctober 23, 201401Add Additional Product SKU